










LATEST NEWS

 <p>The logo for ESCC QPL (European Space Components Coordination Quality Plan) features a globe on the left and the text 'ESCC' in large blue letters above 'QPL' in large blue letters. Below 'ESCC' is the text 'European Space Components Coordination' in a smaller font.</p>	<p>ESCC QPL March 2020</p> <p>The ESCC QPL March was published with 5 Extensions, 2 Revisions, 1 New Certificate</p> <p>For more information, please click HERE</p>
 <p>The logo for ESCC QML (European Space Components Coordination Quality Management List) features a globe on the left and the text 'ESCC' in large blue letters above 'QML' in large blue letters. Below 'ESCC' is the text 'European Space Components Coordination' in a smaller font.</p>	<p>ESCC QML March 2020</p> <p>The QML issue 20 was published in March with 1 NEW certificate for FLUX A/S Denmark for Custom Magnetics (Inductors, Chokes and Transformers)</p>
 <p>The logo for FLUX features a stylized blue 'F' and 'L' intertwined within a globe, all enclosed in a blue circular frame. Below the frame is the word 'FLUX' in large blue letters.</p>	<p>FLUX A/S DENMARK</p> <p>NEW Technology Flow Approval Certificate for FLUX A/S Denmark was published in the QML/QPL March 2020 for Custom Magnetics</p>
 <p>The logo for EPPL (European Process Plan) features the letters 'EPPL' in large blue font over a light blue background with a subtle globe pattern.</p>	<p>ESCC EPPL January 2020</p> <p>The EPPL issue 39 has been published. For more information, click HERE</p>
 <p>The logo for ESCC HPCL (European Space Components Coordination Hybrid Process Capability List) features a globe on the left and the text 'ESCC' in large blue letters above 'HPCL' in large blue letters. Below 'ESCC' is the text 'European Space Components Coordination' in a smaller font.</p>	<p>ESCC Hybrid Process Capability Approval List (HPCL)</p> <p>The New ESCC HPCL issue 3 was published August 2019. This is a list of active and valid Process Capability Approval Certificates for manufacturing Lines of Hybrid Microcircuits, the ESCC HPCL (Hybrid Process Capability Approval List).</p> <p>For more information, please click HERE</p>

UPCOMING EVENTS

	<p>ESCC Training Course: taking place at ESA/ESTEC the Netherlands is Postponed until further notice.</p> <p>For more information, please click HERE</p>
	<p>EMPS Workshops - 11th Electronics Materials & Processes for Space Workshops</p>
	<p>NSREC 2020 - IEEE Nuclear and Space Radiation Effects Conference</p>
	<p>RADECS 2020 - Radiation Effects on Components and Systems Conference</p>

RECENTLY PUBLISHED ESCC SPECIFICATION

NEW ESCC Specifications published since 15th February 2020

Number	Title	Issue
3201/013	CUSTOMISED MAGNETICS (INDUCTORS, TRANSFORMERS) BASED ON TYPE FT	1
3401/096	CONNECTOR SAVERS, ELECTRICAL, RECTANGULAR, MICROMINIATURE, HIGH DATA RATE BASED ON TYPES MICROMACH	1
3401/095	CONNECTORS, ELECTRICAL, RECTANGULAR, MICROMINIATURE, HIGH DATA RATE (FEMALE CONTACTS) BASED ON TYPE MICROMACH	1
3409/002	HIGH DATA RATE CABLE ASSEMBLIES WITH MICROMINIATURE, RECTANGULAR, CONNECTORS BASED ON TYPE MICROMACH	1
3408/003	RF CABLE ASSEMBLY, 2.4mm CONNECTORS, LOW POWER, 50 OHMS, FLEXIBLE CABLE, DC TO 45GHz Based on Type AXOWAVE SL34SQ	1
9202/084	INTEGRATED CIRCUITS, SILICON MONOLITHIC, CMOS, MIXED SIGNAL ASIC BASED ON A RAD-HARD XH018 IP LIBRARY	1

Up-Issued ESCC Specifications published since 15th January 2020

As there are too many specifications up-issued since last month, please click on the link below to view specifications per period

Please click on the link below to see the list:

<https://escies.org/specification/listdif>